



Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from,Europe,America and south Asia,supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of “Quality Parts,Customers Priority,Honest Operation,and Considerate Service”,our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip,ALPS,ROHM,Xilinx,Pulse,ON,Everlight and Freescale. Main products comprise IC,Modules,Potentiometer,IC Socket,Relay,Connector.Our parts cover such applications as commercial,industrial, and automotives areas.

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Contact us

Tel: +86-755-8981 8866 Fax: +86-755-8427 6832

Email & Skype: info@chipsmall.com Web: www.chipsmall.com

Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China



N- and P-Channel 60V (D-S) Power MOSFET

FEATURES

- Low $R_{DS(on)}$ to minimize conductive losses
- Low gate charge for fast power switching
- 100% UIS and R_g tested
- Compliant to RoHS directive 2011/65/EU and in accordance to WEEE 2002/96/EC
- Halogen-free according to IEC 61249-2-21

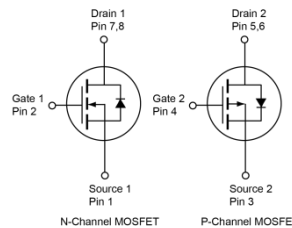
APPLICATIONS

- DC-DC Converters
- Power Routing
- Motor Drives

KEY PERFORMANCE PARAMETERS			
PARAMETER	TYPE	VALUE	UNIT
V_{DS}	N-ch	60	V
	P-ch	-60	
$R_{DS(on)}$ (max)	N-ch	$V_{GS} = 10V$	34
		$V_{GS} = 4.5V$	40
	P-ch	$V_{GS} = -10V$	68
		$V_{GS} = -4.5V$	110
Q_g	N-ch	10.3	nC
	P-ch	9.5	



PDFN56 Dual



Note: MSL 1 (Moisture Sensitivity Level) per J-STD-020

ABSOLUTE MAXIMUM RATINGS ($T_A = 25^\circ C$ unless otherwise noted)				
PARAMETER	SYMBOL	N-ch	P-ch	UNIT
Drain-Source Voltage	V_{DS}	60	-60	V
Gate-Source Voltage	V_{GS}	± 20	± 20	V
Continuous Drain Current (Note 1)	I_D	$T_C = 25^\circ C$	24	-18
		$T_A = 25^\circ C$	5.4	-4
Pulsed Drain Current	I_{DM}	96	-72	A
Single Pulse Avalanche Current (Note 2)	I_{AS}	12.7	-12.7	A
Single Pulse Avalanche Energy (Note 2)	E_{AS}	24	24	mJ
Total Power Dissipation	P_D	$T_C = 25^\circ C$	40	40
		$T_C = 125^\circ C$	8.1	8.1
Total Power Dissipation	P_D	$T_A = 25^\circ C$	2	2
		$T_A = 125^\circ C$	0.4	0.4
Operating Junction and Storage Temperature Range	T_J, T_{STG}	- 55 to +150		$^\circ C$

THERMAL PERFORMANCE			
PARAMETER	SYMBOL	LIMIT	UNIT
Thermal Resistance – Junction to Case	$R_{\theta JC}$	3.1	$^\circ C/W$
Thermal Resistance – Junction to Ambient	$R_{\theta JA}$	61	

Thermal Performance Note: $R_{\theta JA}$ is the sum of the junction-to-case and case-to-ambient thermal resistances. The case-thermal reference is defined at the solder mounting surface of the drain pins. $R_{\theta JA}$ is guaranteed by design while $R_{\theta CA}$ is determined by the user's board design.

ELECTRICAL SPECIFICATIONS ($T_A = 25^\circ\text{C}$ unless otherwise noted)							
PARAMETER	CONDITIONS	SYMBOL	TYPE	MIN	TYP	MAX	UNIT
Static							
Drain-Source Breakdown Voltage	$V_{GS} = 0V, I_D = 250\mu\text{A}$	BV_{DSS}	N-ch	60	--	--	V
	$V_{GS} = 0V, I_D = -250\mu\text{A}$		P-ch	-60	--	--	
Gate Threshold Voltage	$V_{GS} = V_{DS}, I_D = 250\mu\text{A}$	$V_{GS(TH)}$	N-ch	1.2	1.7	2.5	V
	$V_{GS} = V_{DS}, I_D = -250\mu\text{A}$		P-ch	-1.2	-1.5	-2.5	
Gate-Source Leakage Current	$V_{GS} = \pm 20V, V_{DS} = 0V$	I_{GSS}	N-ch	--	--	± 100	nA
	$V_{GS} = \pm 20V, V_{DS} = 0V$		P-ch	--	--	± 100	nA
Drain-Source Leakage Current	$V_{GS} = 0V, V_{DS} = 60V$	I_{DSS}	N-ch	--	--	1	μA
	$V_{GS} = 0V, V_{DS} = 60V$ $T_J = 125^\circ\text{C}$			--	--	100	
	$V_{GS} = 0V, V_{DS} = -60V$		P-ch	--	--	-1	
	$V_{GS} = 0V, V_{DS} = -60V$ $T_J = 125^\circ\text{C}$			--	--	-100	
Drain-Source On-State Resistance <small>(Note 3)</small>	$V_{GS} = 10V, I_D = 5.4A$	$R_{DS(on)}$	N-ch	--	28	34	m Ω
	$V_{GS} = 4.5V, I_D = 4.9A$			--	33	40	
	$V_{GS} = -10V, I_D = -4A$		P-ch	--	57	68	
	$V_{GS} = -4.5V, I_D = -3.2A$			--	73	110	
Forward Transconductance <small>(Note 3)</small>	$V_{DS} = 5V, I_D = 5.4A$	g_{fs}	N-ch	--	19	--	S
	$V_{DS} = -5V, I_D = -4A$		P-ch	--	11	--	
Dynamic <small>(Note 4)</small>							
Total Gate Charge	N-ch $V_{DS} = 30V, I_D = 5.4A$ P-ch $V_{DS} = -30V, I_D = -4A$	$Q_{g(VGS=10V)}$	N-ch	--	20.8	--	nC
		$Q_{g(VGS=-10V)}$	P-ch	--	18.1	--	
Total Gate Charge	N-ch	$Q_{g(VGS=4.5V)}$	N-ch	--	10.3	--	nC
		$Q_{g(VGS=-4.5V)}$	P-ch	--	9.5	--	
Gate-Source Charge	$V_{DS} = 30V, I_D = 4.9A$	Q_{gs}	N-ch	--	3.9	--	nC
			P-ch	--	2.6	--	
Gate-Drain Charge	$V_{DS} = -30V, I_D = -3.2A$	Q_{gd}	N-ch	--	4.2	--	nC
			P-ch	--	4.8	--	
Input Capacitance	N-ch $V_{GS} = 0V, V_{DS} = 30V$	C_{iss}	N-ch	--	1159	--	pF
			P-ch	--	930	--	
Output Capacitance	f = 1.0MHz P-ch	C_{oss}	N-ch	--	59	--	pF
			P-ch	--	65	--	
Reverse Transfer Capacitance	$V_{GS} = 0V, V_{DS} = -30V$ f = 1.0MHz	C_{rss}	N-ch	--	15	--	pF
			P-ch	--	26	--	
Gate Resistance	f = 1.0MHz	R_g	N-ch	0.6	2	4	Ω
			P-ch	4.5	15	30	

ELECTRICAL SPECIFICATIONS ($T_A = 25^\circ\text{C}$ unless otherwise noted)							
PARAMETER	CONDITIONS	SYMBOL	TYPE	MIN	TYP	MAX	UNIT
Switching (Note 4)							
Turn-On Delay Time	N-ch	$t_{d(on)}$	N-ch	--	7.4	--	ns
			P-ch	--	4	--	
Turn-On Rise Time	$V_{GS} = 10\text{V}, V_{DS} = 30\text{V}, I_D = 5.4\text{A}, R_G = 2\Omega$	t_r	N-ch	--	25	--	
			P-ch	--	28	--	
Turn-Off Delay Time	P-ch	$t_{d(off)}$	N-ch	--	18	--	
			P-ch	--	44	--	
Turn-Off Fall Time	$I_D = -4\text{A}, R_G = 2\Omega$	t_f	N-ch	--	18	--	
			P-ch	--	44	--	
Source-Drain Diode							
Forward Voltage (Note 3)	$V_{GS} = 0\text{V}, I_S = 5.4\text{A}$	V_{SD}	N-ch	--	--	1	V
	$V_{GS} = 0\text{V}, I_S = -4\text{A}$		P-ch	--	--	-1	
Reverse Recovery Time	N-ch $I_S = 5.4\text{A}, di/dt = 100\text{A}/\mu\text{s}$	t_{rr}	N-ch	--	16	--	ns
			P-ch	--	13	--	
Reverse Recovery Charge	P-ch $I_S = -4\text{A}, di/dt = 100\text{A}/\mu\text{s}$	Q_{rr}	N-ch	--	11	--	nC
			P-ch	--	7.8	--	

Notes:

- Silicon limited current only.
- N-ch : $L = 0.3\text{mH}, V_{GS} = 10\text{V}, V_{DD} = 25\text{V}, R_G = 25\Omega, I_{AS} = 12.7\text{A}$, Starting $T_J = 25^\circ\text{C}$
 P-ch : $L = 0.3\text{mH}, V_{GS} = -10\text{V}, V_{DD} = -25\text{V}, R_G = 25\Omega, I_{AS} = -12.7\text{A}$, Starting $T_J = 25^\circ\text{C}$
- Pulse test: Pulse Width $\leq 300\mu\text{s}$, duty cycle $\leq 2\%$.
- Switching time is essentially independent of operating temperature.

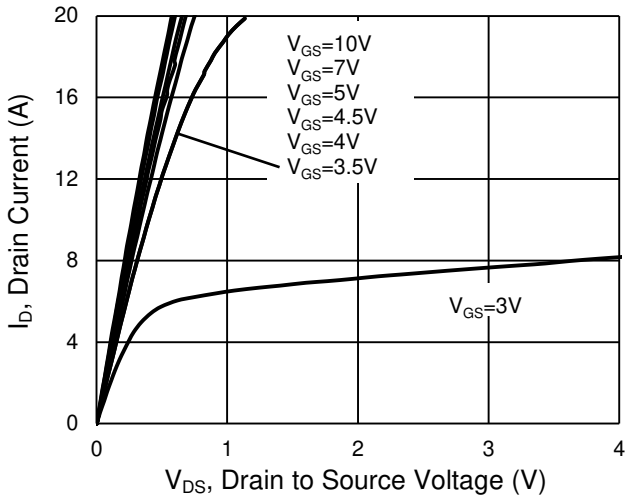
ORDERING INFORMATION

PART NO.	PACKAGE	PACKING
TSM6502CR RLG	PDFN56 Dual	2,500pcs / 13" Reel

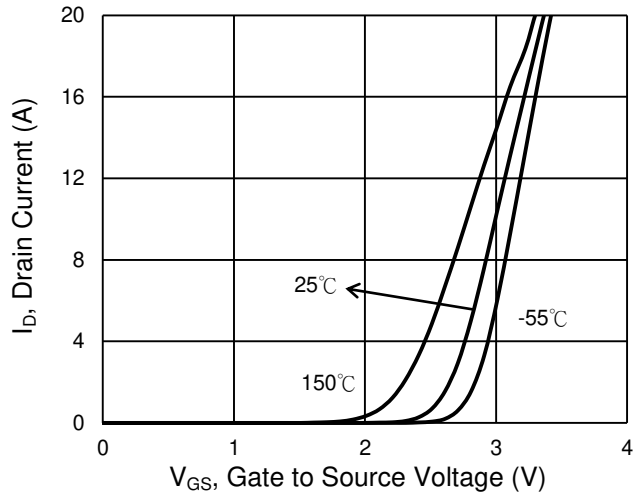
CHARACTERISTICS CURVES (N-Channel)

($T_A = 25^\circ\text{C}$ unless otherwise noted)

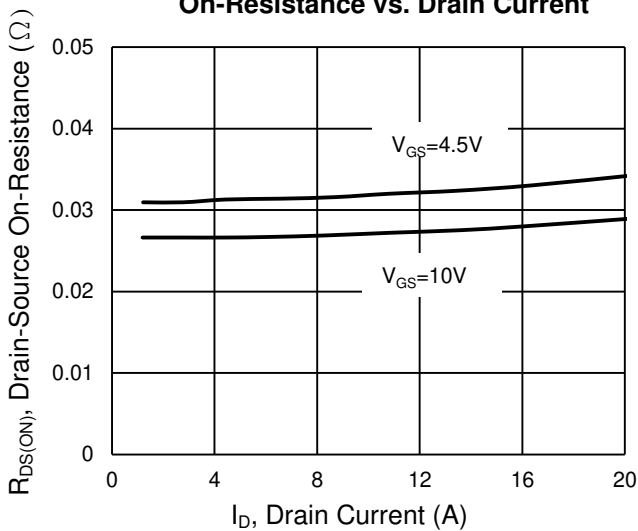
Output Characteristics



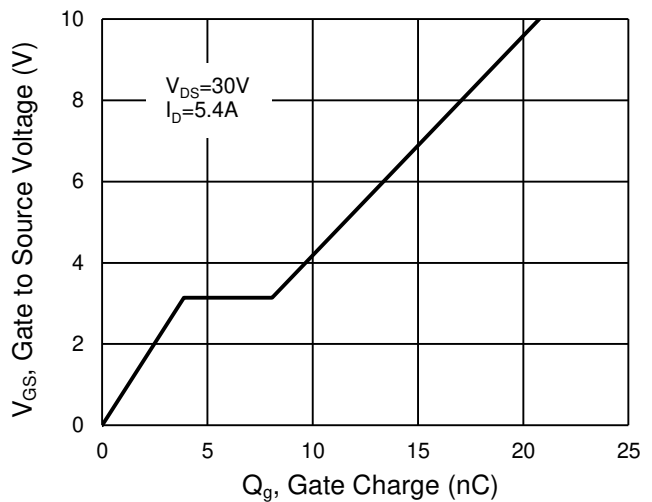
Transfer Characteristics



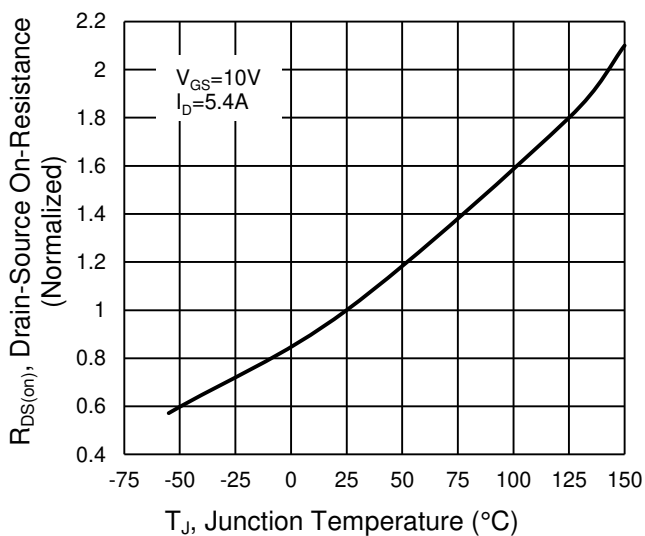
On-Resistance vs. Drain Current



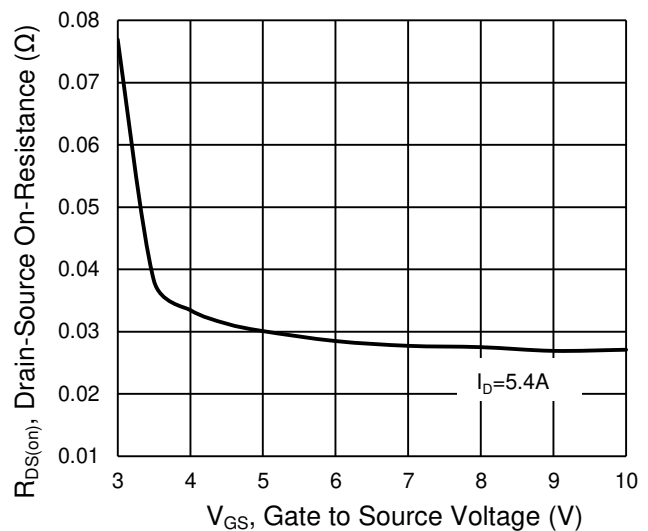
Gate-Source Voltage vs. Gate Charge



On-Resistance vs. Junction Temperature

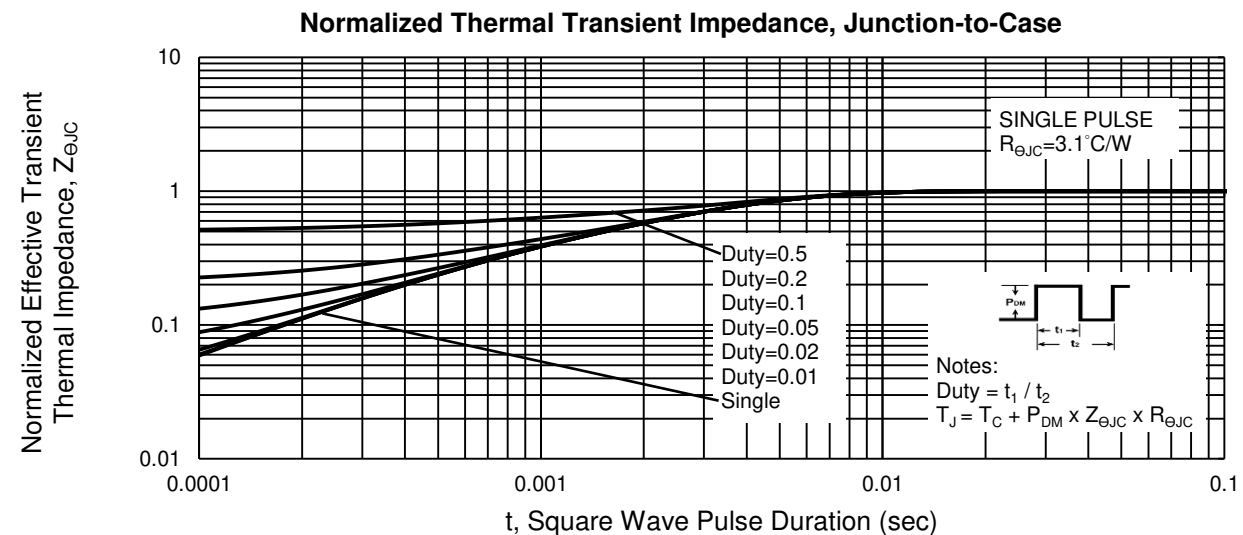
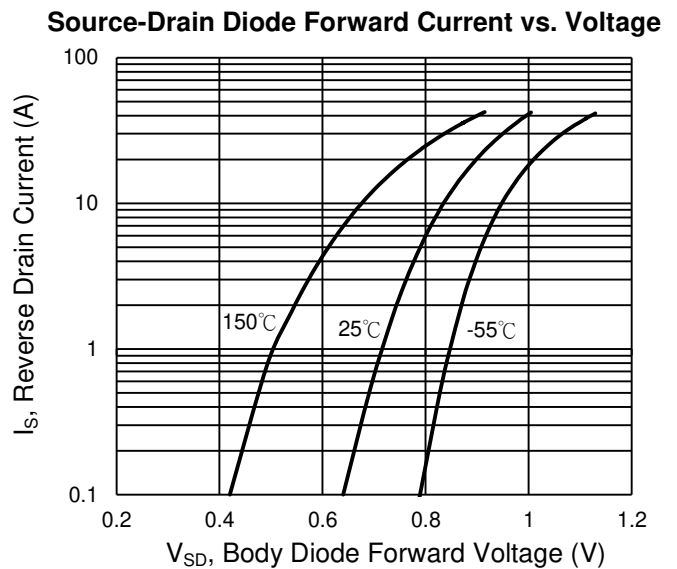
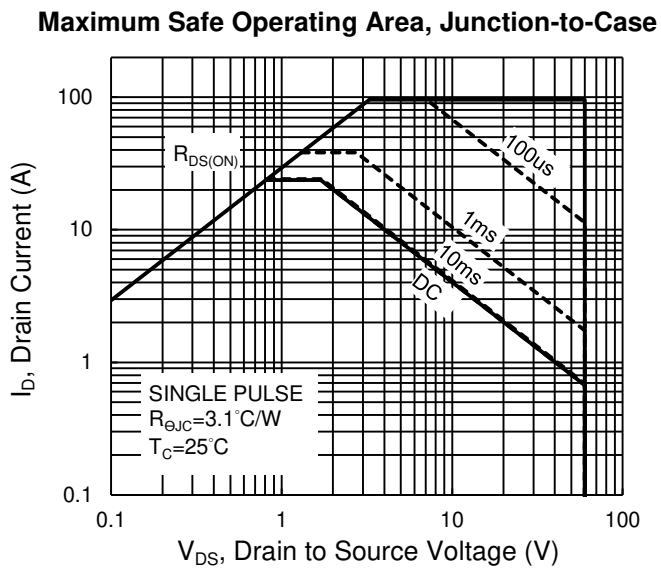
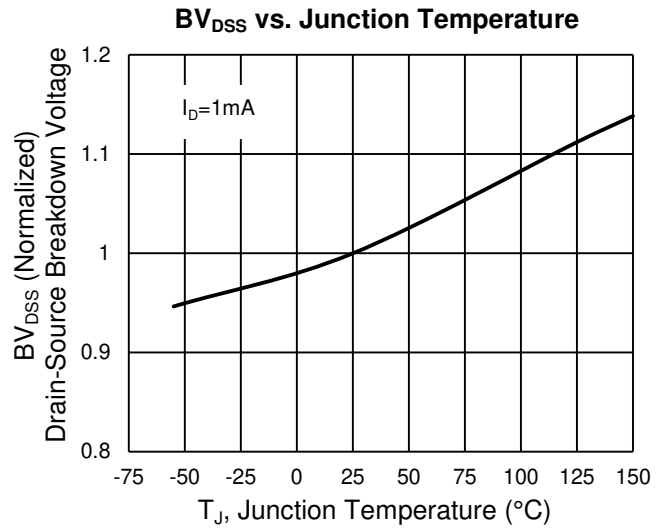
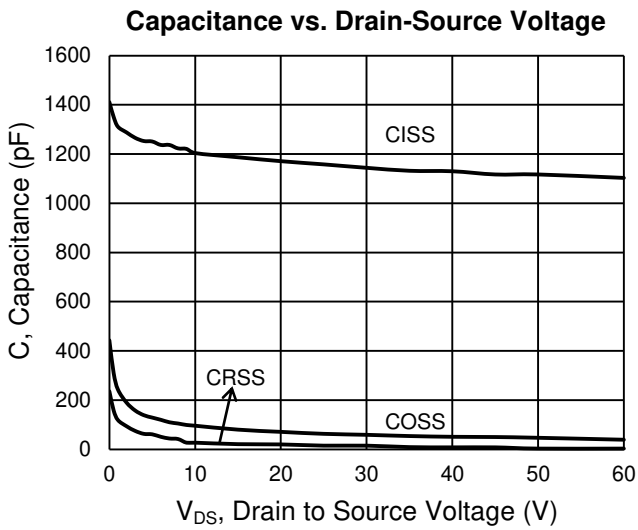


On-Resistance vs. Gate-Source Voltage



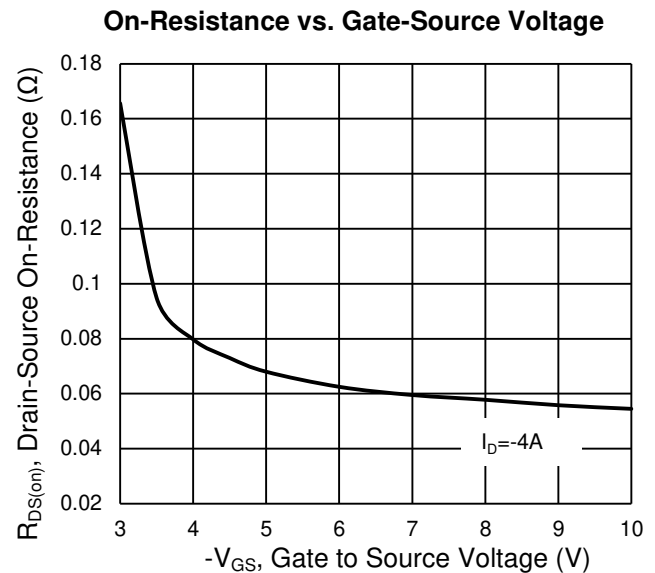
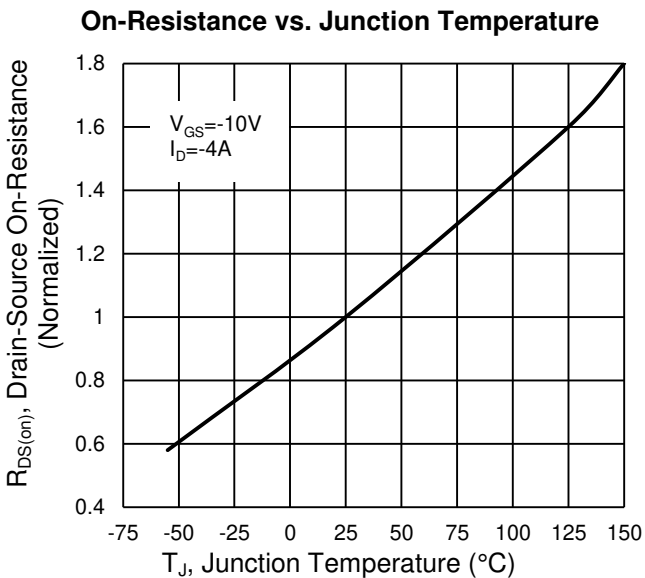
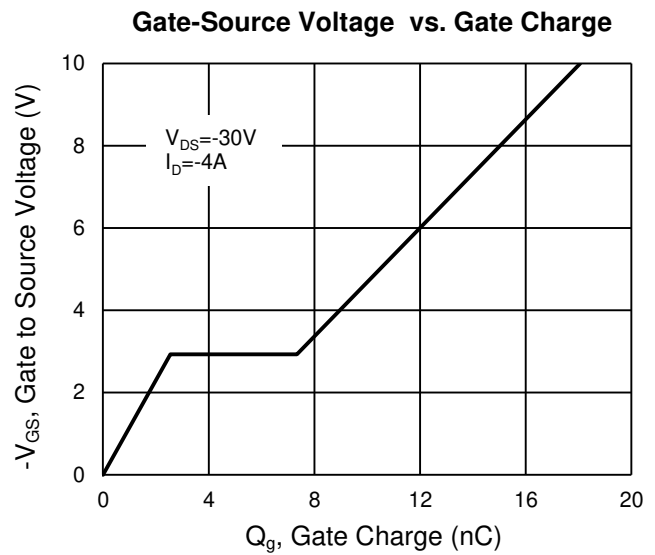
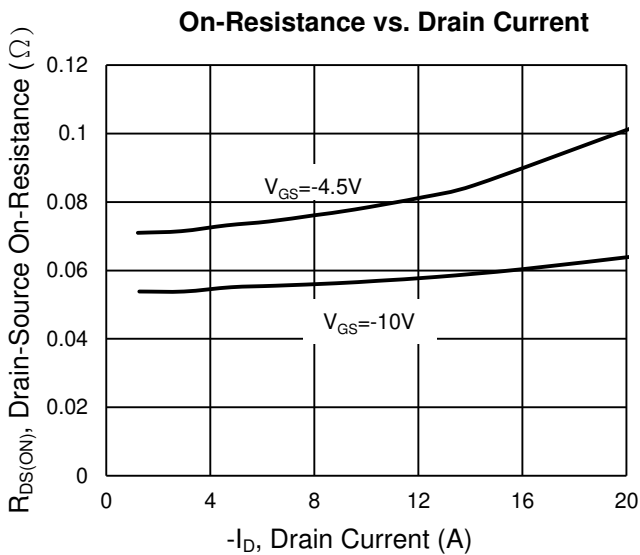
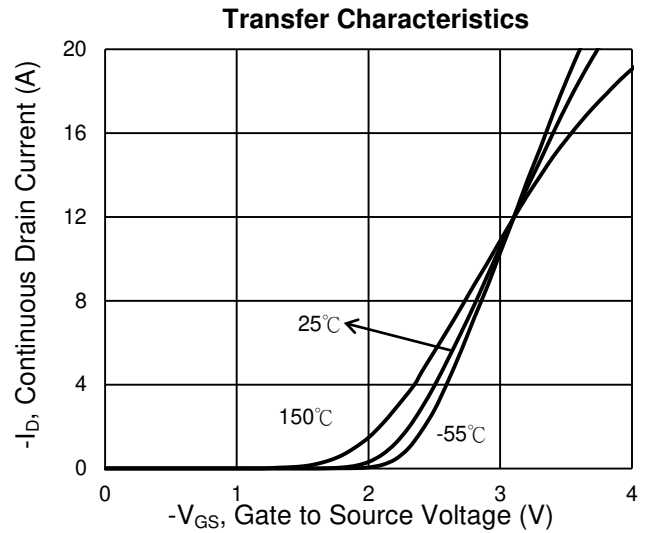
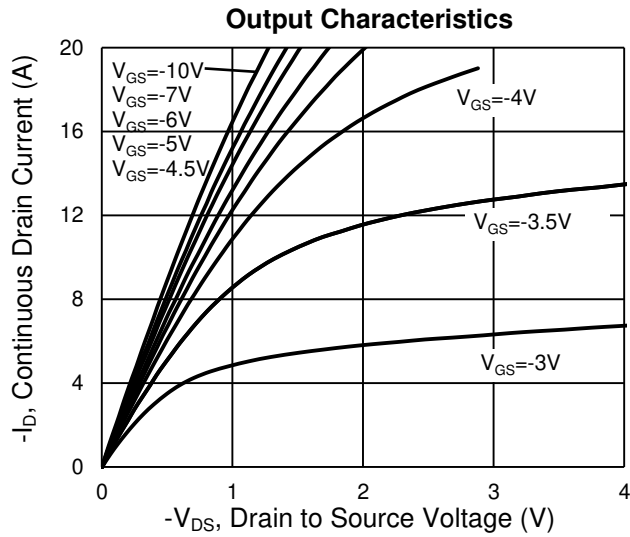
CHARACTERISTICS CURVES (N-Channel)

($T_A = 25^\circ\text{C}$ unless otherwise noted)



CHARACTERISTICS CURVES (P-Channel)

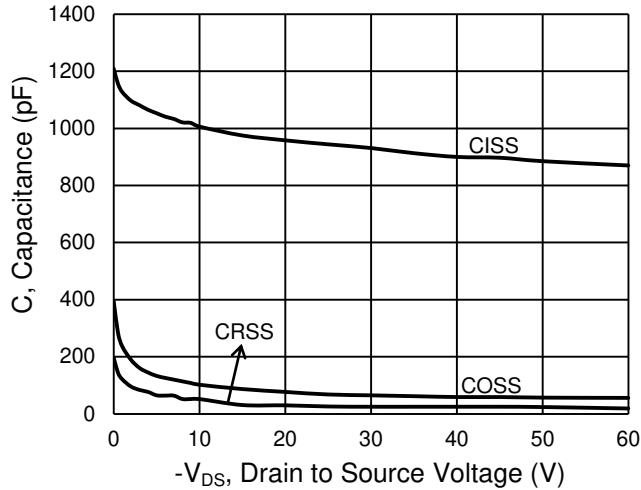
($T_A = 25^\circ\text{C}$ unless otherwise noted)



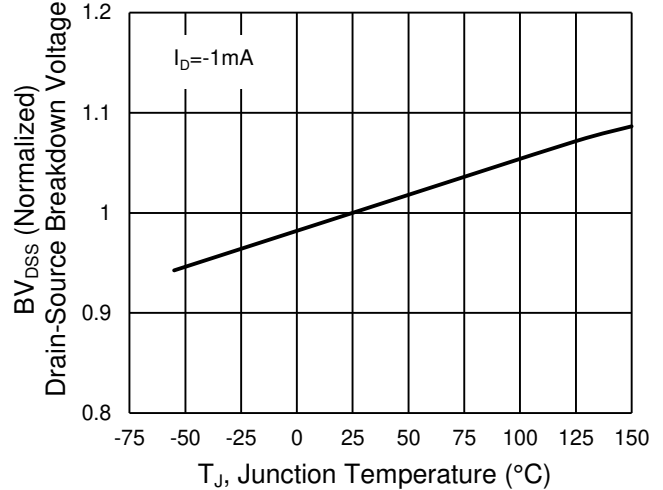
CHARACTERISTICS CURVES (P-Channel)

($T_A = 25^\circ\text{C}$ unless otherwise noted)

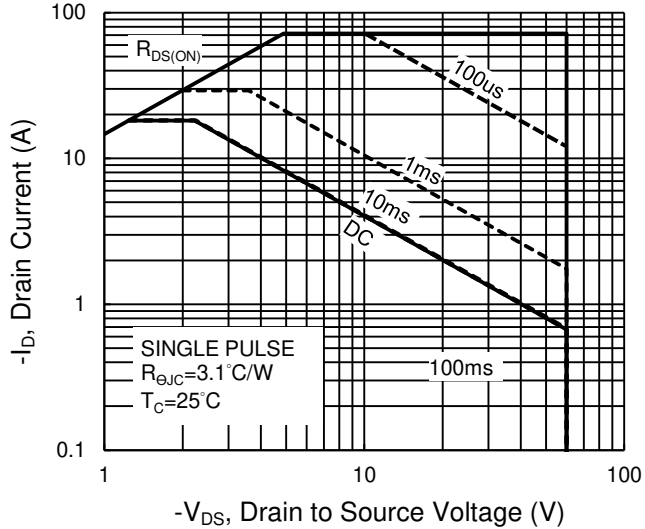
Capacitance vs. Drain-Source Voltage



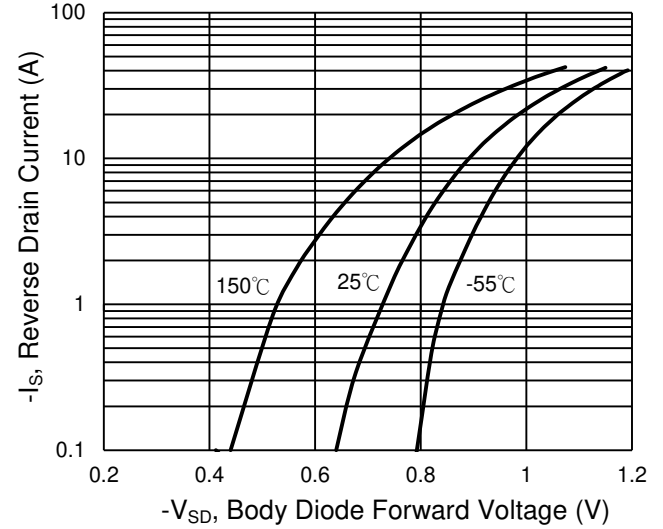
BV_{DSS} vs. Junction Temperature



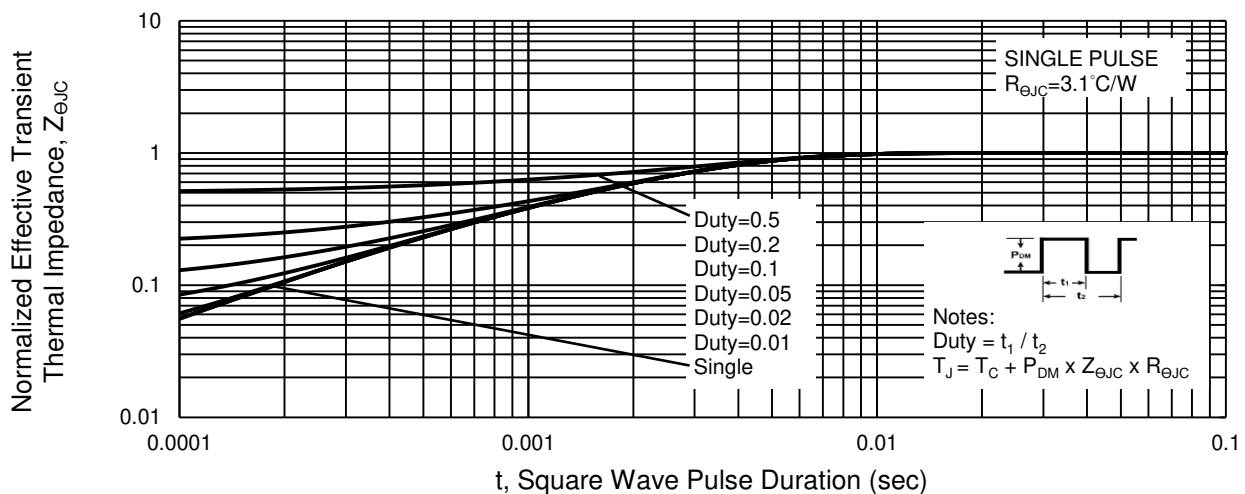
Maximum Safe Operating Area, Junction-to-Case



Source-Drain Diode Forward Current vs. Voltage

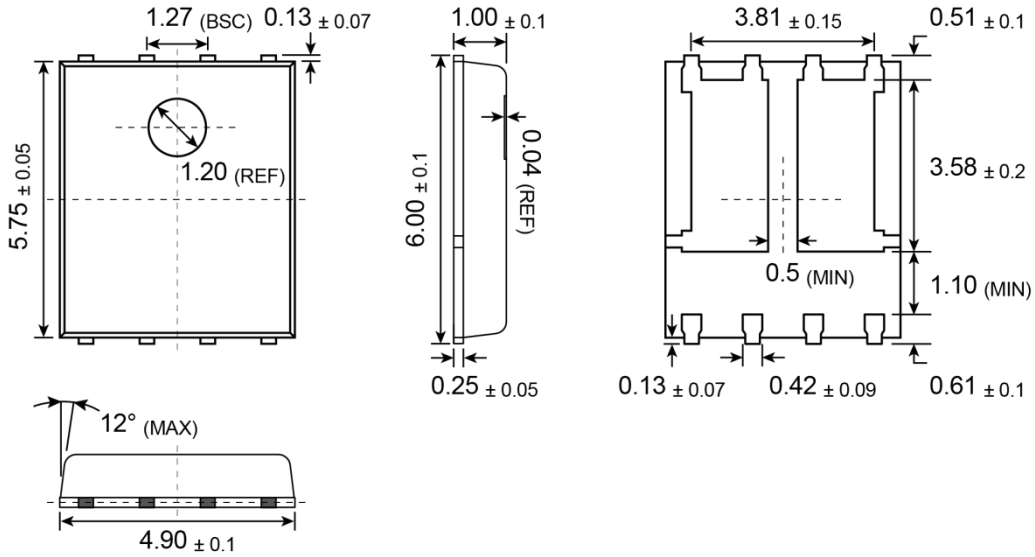


Normalized Thermal Transient Impedance, Junction-to-Case

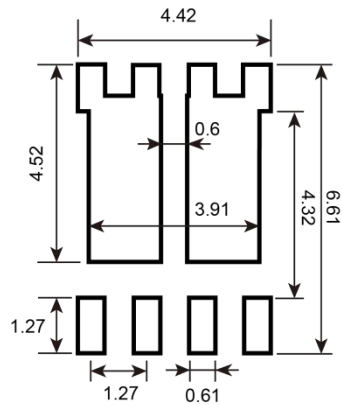


PACKAGE OUTLINE DIMENSIONS (Unit: Millimeters)

PDFN56 Dual



SUGGESTED PAD LAYOUT (Unit: Millimeters)



MARKING DIAGRAM



- G** = Halogen Free
- Y** = Year Code
- WW** = Week Code (01~52)
- F** = Factory Code

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